

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
MING H CHEN	03/27/2015
<b>RECEIVING PARTY DATA</b>	
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<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	14676836
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<b>NAME OF SUBMITTER:</b>	CLIFFORD PERRY
<b>SIGNATURE:</b>	/CliffordBPerry43854/
<b>DATE SIGNED:</b>	04/02/2015
<b>Total Attachments: 1</b>	
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## ASSIGNMENT OF PATENT APPLICATION

WHEREAS, Ming H. Chen of Rancho Palos Verdes California, hereinafter referred to as "Assignor," is an inventor of the invention described and set forth in the following U.S. non-provisional patent application:

Title of Invention: Slot Array Antenna with Dielectric Slab for  
Electrical Control of Beam Down-Tilt

Filing Date: Filed Herewith

Application No.: Not yet Assigned

WHEREAS, Victory Microwave Corporation, located at No. 396, Fude 1st Road, Xizhi District, New Taipei City 22150, Taiwan, R.O.C., hereinafter referred to as "Assignee," is desirous of acquiring an interest in the invention and application, and in any Letters Patent and Registrations which may be granted on the patent application encompassing said invention;

For good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has assigned, and by these presents do assign to Assignee all right, title and interest in and to the invention and application, and to all foreign counterparts (including patent, utility model and industrial designs), and in and to any Letters Patent and Registrations which may be hereafter granted in the United States and all countries throughout the world from the above-identified patent application encompassing said invention, and to claim the priority of this patent application in other applications as assignee desires. The right, title and interest is to be held and enjoyed by Assignee and Assignee's successors and assigns as fully and exclusively as it would have been held and enjoyed by Assignor had this Assignment not been made, for the full term of any Letters Patent and Registrations which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees that s/he will, without charge to Assignee, but at Assignee's expense, (a) cooperate with Assignee in the prosecution of the above-identified US application, foreign counterpart application(s), and any US or foreign patent applications claiming priority to the above-identified US application, (b) execute, verify, acknowledge and deliver all such further papers, including patent applications and instruments of transfer, and (c) perform such other acts as Assignee lawfully may request to obtain or maintain Letters Patent and Registrations for the invention and improvements in any and all countries, and to vest title thereto in Assignee, or Assignee's successors and assigns.

Dated: March 27, 2015

  
MING H. CHEN